

2D200

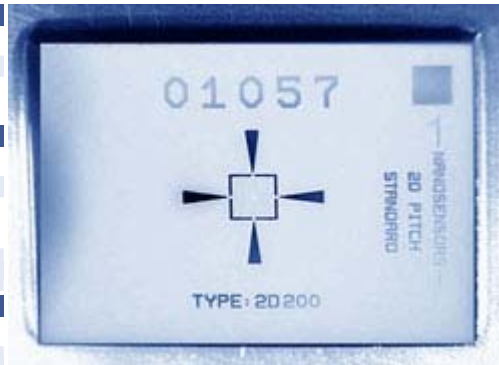
Lateral-(XY)-Calibration Standard

The standard (2D200) is used for a very precise x-y-calibration of the scanning mechanism. The standard consists of a 2-dimensional lattice of inverted square pyramids with 200nm pitch etched into a silicon chip.
A calibration certificate of PTB (Physikalisch Technische Bundesanstalt) is only available on special request. NANOSENSORS™ will mediate a contract between the customer and PTB. Please ask for details.

- Features:**
- 200 nm pitch
 - high accuracy

Detailed Specifications:

Chip	
Chip size:	5 x 7 mm ²
Active area:	100 x 100 μm ²
The active area is located in the center of the chip and is surrounded by the FindMe structure. The lattice of inverted pyramids make up the active area.	
Lattice	
Pitch:	200 nm
Accuracy of pyramid position:	10 nm
Accuracy of pitch (10x10μm ² scan):	0.1 %
Accuracy of pitch (100x100μm ² scan):	±0,01 %
Pyramids	
Edge length of square pyramids:	approx. 100 nm
Sidewall angle (versus wafer surface):	54.7°
Accuracy of sidewall angle:	0.5
Depth of pyramids:	(approx. 70 nm)



Order codes and shipping units:			
Order Code	Quantity	Data Sheet	Calibration Certificat
2D200	1	enclosed	see above

Please download the datasheet for further information (Adobe PDF format) [ds_2D200.pdf](#)
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